PD-95474B



SMPS MOSFET

IRF5801PbF

HEXFET[®] Power MOSFET

Applications

• High frequency DC-DC converters

V _{DSS}	R _{DS(on)} max	I _D
200V	2.2 Ω	0.6A

Benefits

- Low Gate to Drain Charge to Reduce Switching Losses
- Fully Characterized Capacitance Including Effective C_{OSS} to Simplify Design, (See App. Note AN1001)
- Fully Characterized Avalanche Voltage and Current
- Lead-Free
- Halogen-Free

Absolute Maximum Ratings

	TSOP-6
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	Parameter	Max.	Units
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V	0.6	
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 10V	0.48	A
I _{DM}	Pulsed Drain Current ①	4.8	
P _D @T _A = 25°C	Power Dissipation	2.0	W
	Linear Derating Factor	0.016	W/°C
V _{GS}	Gate-to-Source Voltage	± 30	V
dv/dt	Peak Diode Recovery dv/dt ©	9.6	V/ns
TJ	Operating Junction and	-55 to + 150	
T _{STG}	Storage Temperature Range		°C
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)	

Thermal Resistance

Symbol	Parameter	Тур.	Max.	Units
R _{0JA}	Junction-to-Ambient ④		62.5	°C/W

Notes ① through ⑥ are on page 8 www.irf.com

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Static @ $T_J = 25^{\circ}C$ (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	200			V	$V_{GS} = 0V, I_D = 250 \mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.26		V/°C	Reference to 25°C, I _D = 1mA ③
R _{DS(on)}	Static Drain-to-Source On-Resistance			2.2	Ω	$V_{GS} = 10V, I_D = 0.36A$ (3)
V _{GS(th)}	Gate Threshold Voltage	3.0		5.5	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
IDSS	Drain-to-Source Leakage Current			25	μA	$V_{DS} = 200V, V_{GS} = 0V$
USS				250	μΛ	$V_{DS} = 160V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	$V_{GS} = 30V$
	Gate-to-Source Reverse Leakage			-100		V _{GS} = -30V

Dynamic @ $T_J = 25^{\circ}C$ (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
g fs	Forward Transconductance	0.44			S	$V_{DS} = 50V, I_D = 0.36A$
Qg	Total Gate Charge		3.9			I _D = 0.36A
Q _{gs}	Gate-to-Source Charge		0.8		nC	V _{DS} = 160V
Q _{gd}	Gate-to-Drain ("Miller") Charge		2.2			$V_{GS} = 10V$
t _{d(on)}	Turn-On Delay Time		6.5			V _{DD} = 100V
tr	Rise Time		8.0		ns	I _D = 0.36A
t _{d(off)}	Turn-Off Delay Time		8.8			$R_G = 53\Omega$
t _f	Fall Time		19			V _{GS} = 10V ③
C _{iss}	Input Capacitance		88			$V_{GS} = 0V$
Coss	Output Capacitance		18			$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		6.3		pF	f = 1.0MHz
Coss	Output Capacitance		102			$V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0MHz$
Coss	Output Capacitance		8.4			$V_{GS} = 0V, V_{DS} = 160V, f = 1.0MHz$
C _{oss} eff.	Effective Output Capacitance		26			$V_{GS} = 0V, V_{DS} = 0V$ to 160V $\$

Avalanche Characteristics

	Parameter	Тур.	Max.	Units
E _{AS}	Single Pulse Avalanche Energy@		9.9	mJ
I _{AR}	Avalanche Current①		0.6	Α

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions		
I _S	Continuous Source Current			1.8		MOSFET symbol		
	(Body Diode)		1.0	A	showing the			
I _{SM}	Pulsed Source Current			48	integral reverse			
	(Body Diode) ①					p-n junction diode.		
V_{SD}	Diode Forward Voltage			1.3	V	$T_J = 25^{\circ}C, I_S = 0.36A, V_{GS} = 0V$ 3		
t _{rr}	Reverse Recovery Time		45		ns	T _J = 25°C, I _F = 0.36A		
Q _{rr}	Reverse RecoveryCharge		54		nC	di/dt = 100A/µs ③		
2	·	•				www.irf.com		

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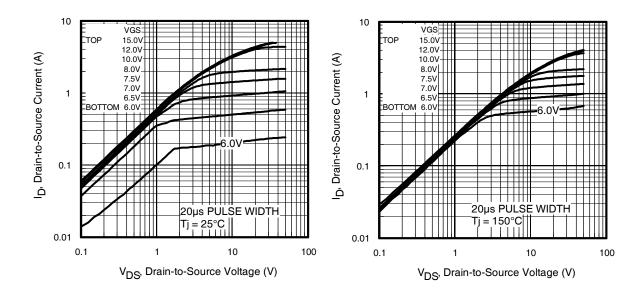
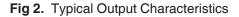


Fig 1. Typical Output Characteristics



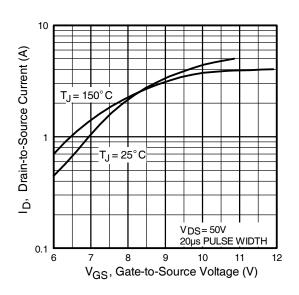


Fig 3. Typical Transfer Characteristics

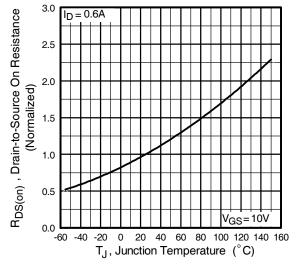


Fig 4. Normalized On-Resistance Vs. Temperature

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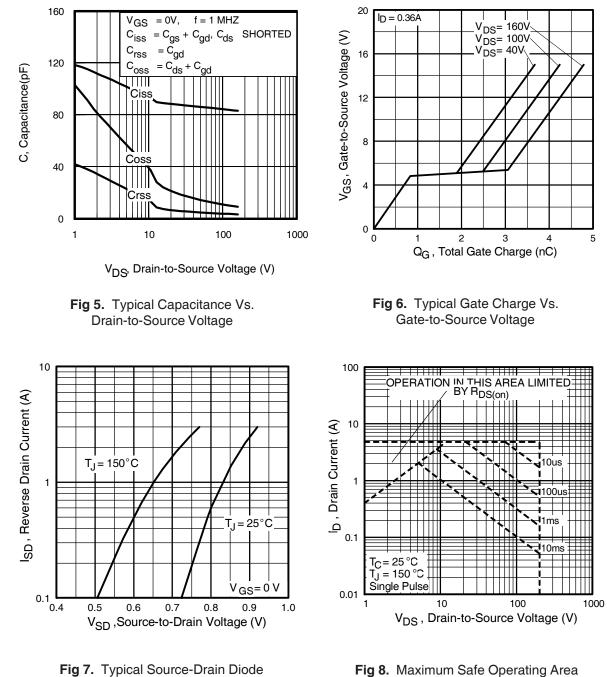
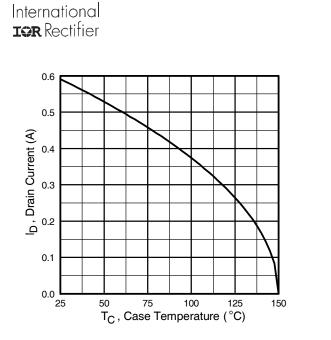


Fig 8. Maximum Safe Operating Area

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Forward Voltage





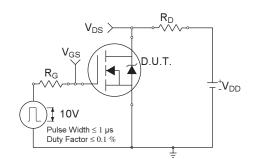


Fig 10a. Switching Time Test Circuit

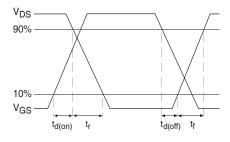


Fig 10b. Switching Time Waveforms

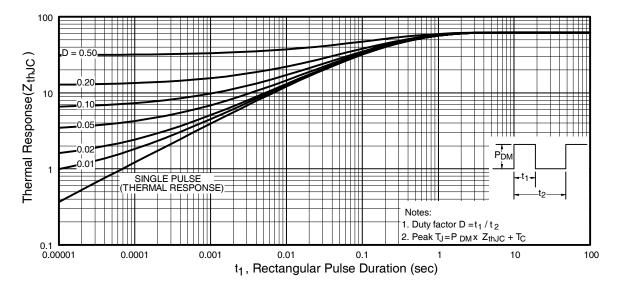
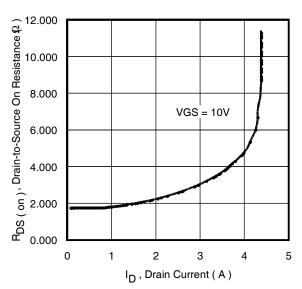


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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(1.500) (1.5

2.500

Fig 12. On-Resistance Vs. Drain Current

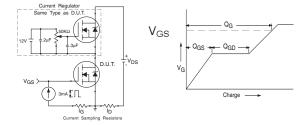


Fig 14a&b. Basic Gate Charge Test Circuit and Waveform

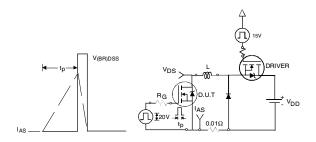


Fig 15a&b. Unclamped Inductive Test circuit and Waveforms

Fig 13. On-Resistance Vs. Gate Voltage

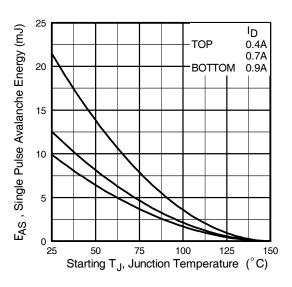
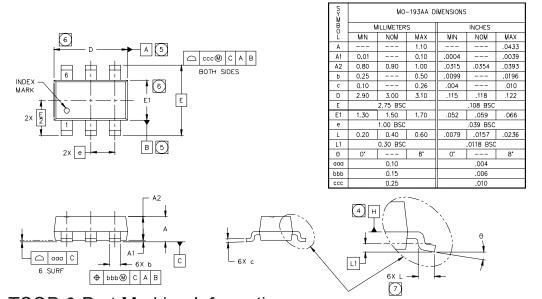


Fig 15c. Maximum Avalanche Energy Vs. Drain Current

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International **IOR** Rectifier **TSOP-6 Package Outline**



TSOP-6 Part Marking Information

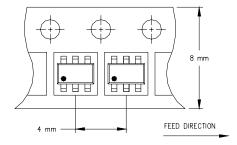
W = (1-26) IF PRECEDED BY LAST DIGIT OF CALENDAR YEAR

DATE CODE	YEAR	Y	WORK WEEK	W
	2001	1	01	А
	2002	2	02	В
	2003	3	03	С
A YW LC	2004	4	04	D
	2005	5		i.
/⊟ ⊟ ⊢ LOT	2006	6		
CLEW/REINDICATOR TOP CODE	2007	7		
CU-WIRE INDICATOR TOP	2008	8	1	L
	2009	9	1	1
	2010	0	24	Х
PART NUMBER CODE REFERENCE:			25	Y
			26	Z
A = SI3443DV K = IRF5810	(07.50) IE	DDEO		ETTED
$B = IRF5800 \qquad L = IRF5804 \qquad \qquad W =$	(27 - 52) IF	PREU	EDED BY A I	ETTER
C = IRF5850 $M = IRF5803$			WORK	
$D = IRF5851 \qquad N = IRF5802$	YEAR	Y	WEEK	W
E = IRF5852	2001	А	27	A
F = IRF5801	2002	B	28	В
I = IRF5805	2003	č	29	Č
	2004	Ď	30	Ď
J = IRF5806	2005	E		
	2006	F		
Notes:	2007	G		
-A line above the work week (as shown here) indicates Lead-Free	2008	Н		1
A line below the part number (as shown here) indicates Cu-wire	2009	J	V	
	2010	Κ	50	Х
			51	Y
			52	Z

Note: For the most current drawing please refer to IR website at: <u>http://www.irf.com/package/</u> www.irf.com

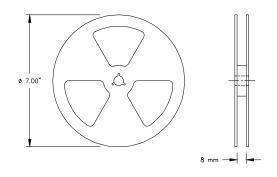
TSOP-6 Tape & Reel Information

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NOTES:

1. OUTLINE CONFORMS TO EIA-481 & EIA-541.



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Notes:

① Repetitive rating; pulse width limited by max. junction temperature.

③ Pulse width \leq 400µs; duty cycle \leq 2%.

④ When mounted on 1 inch square copper board, t < 10sec.

S C_{_{OSS}} eff. is a fixed capacitance that gives the same charging time as C_{_{OSS}} while V_{_{DS}} is rising from 0 to 80% V_{_{DSS}}.

 $\label{eq:ISD} \begin{tabular}{ll} \hline & I_{SD} \leq 0.36A, \ di/dt \leq 93A/\mu s, \ V_{DD} \leq V_{(BR)DSS}, \ T_J \leq 150^\circ C. \end{tabular}$

Data and specifications subject to change without notice. This product has been designed and qualified for the Consumer market. Qualification Standards can be found on IR's Web site.

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